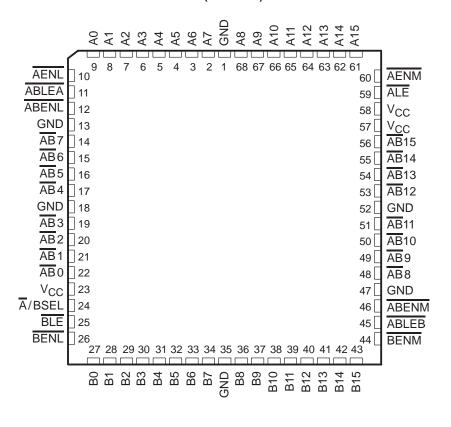
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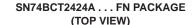
- Multiplexed Real-Time and Latched Data
- Byte Control for Byte-Write Applications
- Useful in NuBus<sup>™</sup> Interface Applications
- Useful in Memory Interleave Applications
- BiCMOS Design Substantially Reduces Standby Current
- Dependable Texas Instruments Quality and Reliability

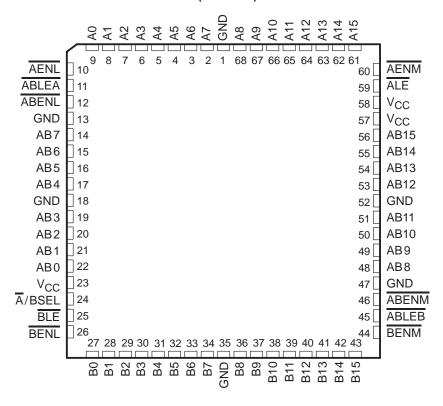
SN74BCT2423A . . . FN PACKAGE (TOP VIEW)



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## description

The 'BCT2423A and 'BCT2424A are general-purpose 16-bit bidirectional transceivers with data storage latches and byte control circuitry arranged for use in applications where two separate data paths must be multiplexed onto, or demultiplexed from, a single data path. Typical applications include multiplexing and/or demultiplexing of address and data information in microprocessor- or bus-interface applications. These devices are also useful in memory-interleaving applications. The 'BCT2423A and 'BCT2424A offer inverted and noninverted data paths, respectively.

The 'BCT2423A and 'BCT2424A were designed using Texas Instruments BiCMOS process, which features bipolar drive characteristics, but also greatly reduces the standby power of the device when disabled. This is valuable when the device is not performing an address or data transfer.

Three 16-bit I/O ports, A15-A0, B15-B0, and AB15-AB0 are available for address and/or data transfer. The AENM, AENL, BENM, BENL, ABENM, and ABENL inputs control the bus transceiver functions. These control signals also allow byte-control of the most significant byte and least significant byte for each bus.

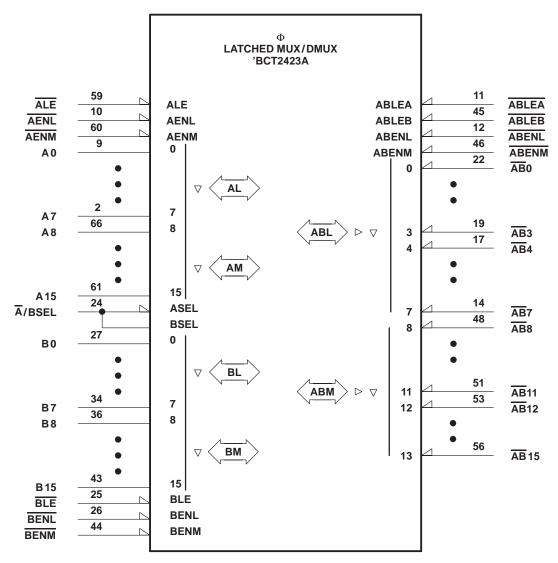
Address and/or data information can be stored using the internal storage latches. The ALE, BLE, ABLEA, and ABLEB inputs are active low, and are used to control data storage. When the latch enable input is low, the latch is transparent. When the latch enable input goes high, the data present at the inputs is latched, and remains latched until the latch enable input is returned low.

Data on the 'A' bus and 'B' bus are multiplexed onto the 'AB' bus via the  $\overline{A}$ /BSEL control line. When  $\overline{A}$ /BSEL is low, A15–A0 is mapped to the AB15–AB0 outputs. When  $\overline{A}$ /BSEL is high, B15–B0 is mapped to the AB15–AB0 outputs.

The SN74BCT2423A and SN74BCT2424A are characterized for operation from 0°C to 70°C.

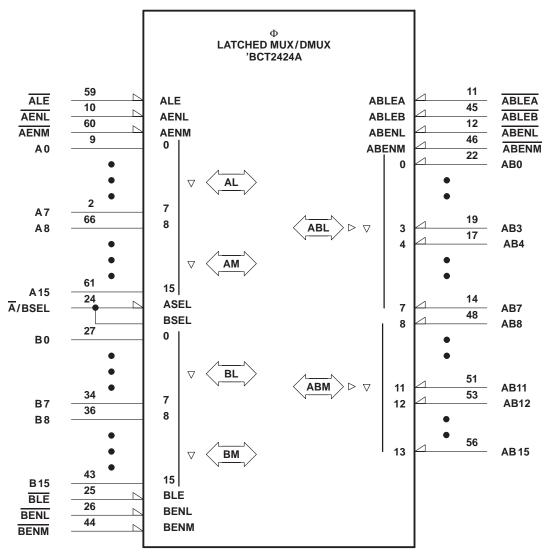


# logic symbol for the 'BCT2423A<sup>†</sup>



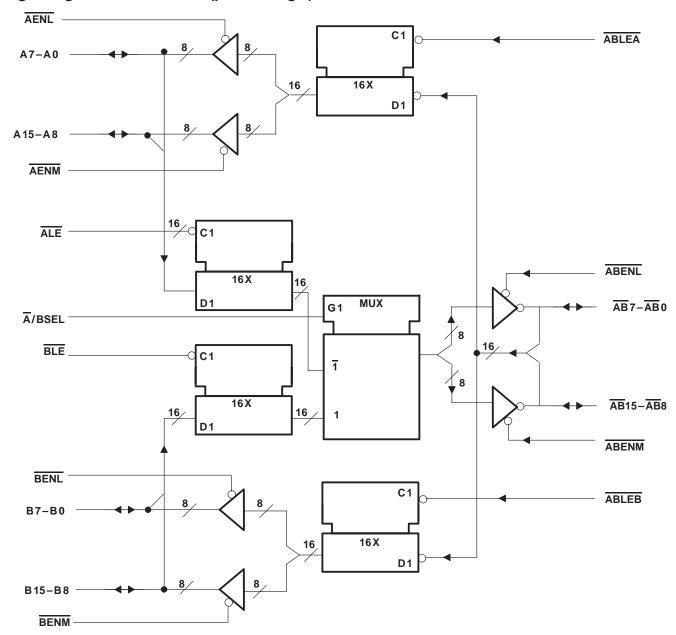
<sup>†</sup> These logic symbols are in accordance with ANSI/IEEE Std 91-1984.

## logic symbol for the 'BCT2424AT



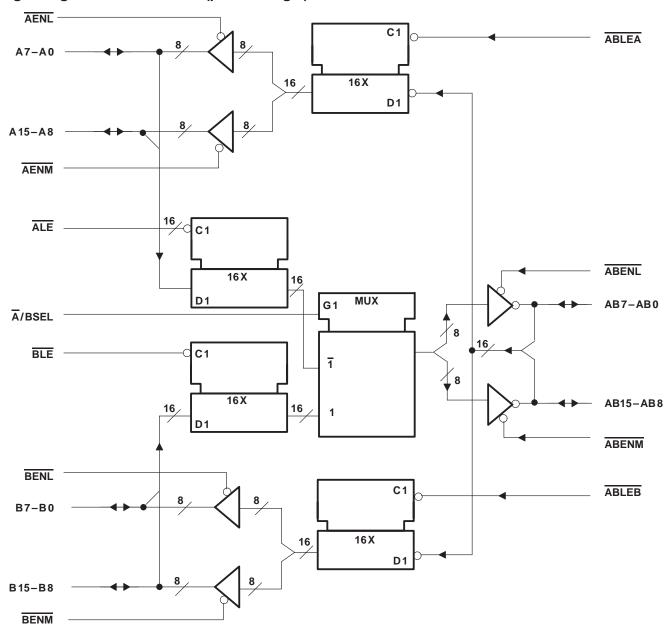
<sup>†</sup> These logic symbols are in accordance with ANSI/IEEE Std 91-1984.

# logic diagram for 'BCT2423A (positive logic)



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## logic diagram for 'BCT2424A (positive logic)



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## **Terminal Functions**

TERMINAL PINS	DESCRIPTION
A15-A0	A bus. This 16-bit I/O port allows for transmission of data and/or address information to or from the AB bus. Information transfer between the A bus and the AB bus is inverting for the 'BCT2423A and noninverting for the 'BCT2424A.
AB 15 – AB 0 ('BCT 2423A) AB 15 – AB 0 ('BCT 2424A)	AB Bus. This 16-bit i/o port allows for multiplexed transmission of data and/or address information to or from the A and B buses. Information transfer between the A, B, and AB buses is inverting for the 'BCT2423A and noninverting for the 'BCT2424A.
ABENL	AB Bus Output Enable, Least Significant Byte. This active-low input is used to enable the AB7-AB0 outputs. When this input is high, the AB7-AB0 outputs are in the high-impedance state allowing for data input.
ABENM	AB Bus Latch Enable, Most Significant Byte. This active-low input is used to enable the AB15–AB8 outputs. When this input is high, the AB15–AB8 outputs are in the high-impedance state allowing for data input.
ABLEA	AB Bus Latch Enable to A Bus. This active-low input is used to contr <u>ol</u> the latch that holds data received from the AB bus (AB15–AB0) to be transferred to the A bus (A15–A0). When ABLEA is low, the latch is transparent. When ABLEA transitions to the high level, the data present at the AB15 – AB0 inputs is latched, and it remains latched while ABLEA is high.
ABLEB	AB Bus Latch Enable to B Bus. This active-low input is used to control the latch that holds data received from the AB bus (AB15–AB0) to be transferred to the B bus (B15–B0). When ABLEB is low, the latch is transparent. When ABLEB transitions to the high level, the data present at the AB15 – AB0 inputs is latched, and it remains latched while ABLEB is high.
Ā/BSEL	A/B Select Control. This input controls the A/B multiplexer. When the input is low, the A15-A0 is selected as input to the AB15-AB0 outputs. When the input is high, B15-B0 is selected as input to the AB15-AB0 outputs.
AENL	A Bus Output Enable, Least Significant Byte. This active-low input is used to enable the A7 – A0 outputs. When this input is high, the A7 – A0 outputs are in the high-impedance state allowing for data input.
AENM	A Bus Output Enable, Most Significant Byte. This active-low input is used to enable the A15 – A8 outputs. When this input is high, the A15 – A8 outputs are in the high-impedance state allowing for data input.
ALE	A Bus Latch Enable. This active-low input is used to control the latch that holds data received from the A bus (A15 – A0). When ALE is low, that latch is transparent. When ALE transitions to the high level, the data present at the A15 – A0 inputs is latched and remains latched while ALE is high.
B15-B0	B Bus. This 16-bit I/O port allows for transmission of data and/or address information to or from the AB bus. Information transfer between the B bus and the AB bus is inverting for the 'BCT2423A and noninverting for the 'BCT2424A.
BENL	B Bus Output Enable, Least Significant Byte. This active-low input is used to enable the B7-B0 outputs. When this input is high, the B7-B0 outputs are in the high-impedance state allowing for data input.
BENM	B Bus Output Enable, Most Significant Byte. This active-low input is used to enable the B15 – B8 outputs. When this input is high, the B15 – B8 outputs are in the high-impedance state allowing for data input.
BLE	B Bus Latch Enable. This active-low input is used to control the latch that holds data received from the B bus (B15-B0). When BLE is low, that latch is transparent. When BLE transitions to the high level, that data present at the B15-B0 inputs is latched and remains latched while BLE is high.



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### **Function Tables**

	DIRECTION A OR B TO AB									
INPUTS							OUT	PUTS		
	INPUIS						'ВСТ	2423A	'ВСТ	2424A
Ax	Вх	ALE	BLE	A/BSEL	ABENM	ABENL	AB 15–8	AB 7–0	AB 15–8	AB 7-0
Н	Х	L	Х	L	L	L		_	ŀ	1
L	Χ	L	X	L	L	L	Н		H L	
Х	Х	Н	X	L	L	L	ĀB <sub>0</sub>		AB <sub>0</sub>	
Х	Н	Х	L	Н	L	L	L		Н	
Х	L	Х	L	Н	L	L	 	4	L	
Х	Х	Χ	Н	Н	L	L	Al	B <sub>0</sub>	Al	30
Х	Х	Х	Х	Х	L	L	Active	Active	Active	Active
Х	Х	Χ	X	X	L	Н	Active	Z	Active	Z
Х	Χ	Χ	Χ	X	Н	L	Z	Active	Z	Active
Х	Χ	Χ	Χ	X	Н	Н	Z	Z	Z	Z

	DIRECTION AB TO A OR B							
		INPUTS			OUTI	PUTS		
ABx	ADLEA	ADLED	AENL†	BENL†	'ВСТ	2423A	'ВСТ	2424A
ABx	ABLEA	ABLEB	AENM†	BENM†	Ax	Bx	Ax	Вх
Н	L	L	L	L	L	L	Н	Н
L	L	L	L	L	Н	Н	L	L
Н	L	Н	L	L	L	B <sub>0</sub>	Н	В0
L	L	Н	L	L	Н	В0	L	В0
Н	Н	L	L	L	A <sub>0</sub>	L	A <sub>0</sub>	Н
L	Н	L	L	L	A <sub>0</sub>	Н	A <sub>0</sub>	L
Χ	Н	Н	L	L	A <sub>0</sub>	В <sub>0</sub>	A <sub>0</sub>	В <sub>0</sub>
Х	Х	Х	L	L	Active	Active	Active	Active
Χ	Χ	Χ	L	Н	Active	Z	Active	Z
Χ	Χ	Χ	Н	L	z	Active	Z	Active
Χ	X	Χ	Н	Н	z	Z	Z	Z

H = high level, L = low level, X = irrelevant, Z = high impedance.

 $A_0$ ,  $B_0$ ,  $AB_0$  = no change since the controlling latch enable went high

<sup>†</sup>The least significant bytes (A7-A0 and B7-B0) and the most significant bytes (A15-A8 and B15-B8) can be independently enabled and disabled, as was illustrated for the  $\overline{AB}$  and AB bytes in the upper function table.

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# 

## recommended operating conditions

	PARAMETER					UNIT
Vcc	Supply voltage	4.75	5	5.25	V	
VIH	High-level input voltage		2			V
V <sub>IL</sub>	Low-level input voltage				0.8	V
la	High-level output current	$A_X$ , $B_X$ outputs			-15	mA
ЮН	nign-iever output current	$\overline{AB}_X$ or $AB_X$ outputs			-15	IIIA
la	Low-level output current	A <sub>X</sub> , B <sub>X</sub> outputs			24	mA
lor	Low-level output current	AB <sub>X</sub> or AB <sub>X</sub> outputs			48	IIIA
	Pulse duration	ABLEA, ABLEB high or low	12.5			
t <sub>W</sub>	Pulse duration	ALE, BLE high or low	12.5			ns
t <sub>su</sub>	Setup time	Data before xLEx ↑	10			ns
th	Hold time	Data after xLEx ↑	2			ns
TA	Operating free-air temperature		0		70	°C

## electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CO	ONDITIONS	MIN	TYP†	MAX	UNIT
VIK		$V_{CC} = 4.75 V,$	I <sub>I</sub> = -18 mA			-1.2	V
		$V_{CC} = 4.75 V,$	I <sub>OH</sub> = -400 μA	V <sub>CC</sub> – 1.5			
Vон		$V_{CC} = 4.75 V$	$I_{OH} = -3 \text{ mA}$	2.8	3.6		V
		$V_{CC} = 4.75 V$	$I_{OH} = -15 \text{ mA}$	2			٧
	Av. B. outpute	$V_{CC} = 4.75 V$ ,	$I_{OL} = 12 \text{ mA}$		0.25	0.4	
\/o:	Aχ, B <sub>χ</sub> outputs	$V_{CC} = 4.75 V$ ,	$I_{OL} = 24 \text{ mA}$		0.35	0.5	
VOL	A <sub>X</sub> , B <sub>x</sub> outputs	$V_{CC} = 4.75 V$ ,	$I_{OL} = 24 \text{ mA}$		0.25	0.4	V
	AX, BX outputs	$V_{CC} = 4.75 V$ ,	$I_{OL} = 48 \text{ mA}$		0.35	0.5	
IĮ		$V_{CC} = 5.25 V$ ,	V <sub>I</sub> = 5.5 V			100	μΑ
I <sub>IH</sub> ‡		V <sub>CC</sub> = 5.25 V,	V <sub>I</sub> = 2.7 V			20 -100	μΑ
I <sub>IL</sub> ‡		$V_{CC} = 5.25 V,$	V <sub>I</sub> = 0.4 V			-200	μΑ
los§		$V_{CC} = 5.25 V,$	V <sub>0</sub> = 0	-60		-225	mA
1	Enabled	$V_{CC} = 5.25 V$ ,	V <sub>IL</sub> = 0.5 V,		110	170	mΛ
ICC	Disabled	V <sub>IH</sub> = 3 V,	Outputs open		20	40	mA

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25 \,^{\circ}\text{C}$ .



<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the "recommended operating conditions" section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND.

<sup>‡</sup> For I/O ports, the parameter I<sub>IH</sub> and I<sub>IL</sub> include the offstate output current.

<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

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# switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS‡	MIN TYPT	MAX	UNIT
t <sub>pd</sub>	ABx, ABx	Ax		8	12	ns
t <sub>pd</sub>	ABx, ABx	Вх		8	12	ns
t <sub>pd</sub>	Ax	ABx, ABx		9	12	ns
t <sub>pd</sub>	Bx	ABx, ABx		9	12	ns
<sup>t</sup> pd	<u>ALE</u> ↓	ABx, ABx		10	13	ns
t <sub>pd</sub>	BLE ↓	ABx, ABx		10	13	ns
t <sub>pd</sub>	ABLEA↓	Ax		8	12	ns
t <sub>pd</sub>	ABLEB ↓	Bx		8	12	ns
t <sub>pd</sub>	A/BSEL	ABx, ABx	V <sub>CC</sub> = 4.75 V to 5.25 V,	8	12	ns
<sup>t</sup> en	AENM, AENL	Ax	$C_L = 50 \text{ pF},$ $R_1 = 500 \Omega, R_2 = 500 \Omega,$	10	13	ns
<sup>t</sup> en	BENM, BENL	Вх	T <sub>A</sub> = MIN to MAX	10	13	ns
<sup>t</sup> en	ABENM, ABENL	ABx, ABx		10	13	ns
<sup>t</sup> dis	AENM, AENL	Ax		5	10	ns
<sup>t</sup> dis	BENM, BENL	Вх		5	10	ns
<sup>t</sup> dis	ABENM, ABENL	ABx, ABx		5	10	ns

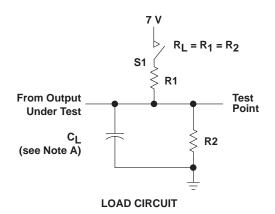
<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25 ^{\circ}\text{C}$ .

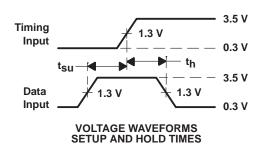
<sup>‡</sup> See Parameter Measurement Information for load circuit and voltage waveforms.

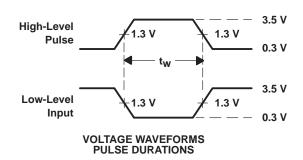
#### PARAMETER MEASUREMENT INFORMATION

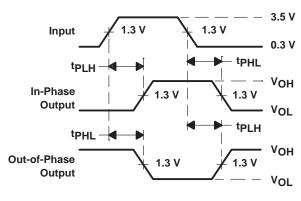
#### **SWITCH POSITION TABLE**

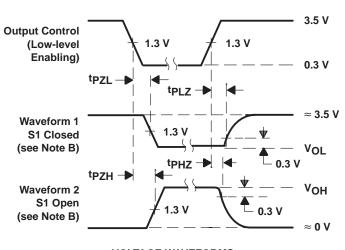
TEST	S1
tPLH	Open
tPHL	Open
tPZH	Open
tPZL	Closed
tPHZ	Open
tPLZ	Closed











VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

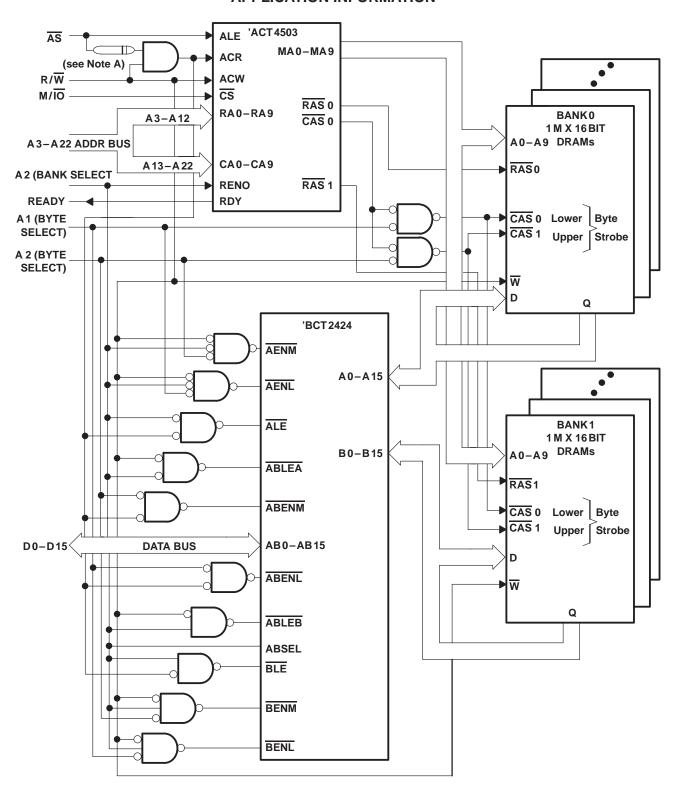
VOLTAGE WAVEFORMS
ENABLE AND DISABLED TIMES, 3-STATE OUTPUTS

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Wafeform 1 is for an output with internal conditions such that the output is low except when disabled by the current control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses have the following characteristics:  $PRR \le 1$  MHz,  $t_f = t_f = 2$  ns, duty cycle = 50%.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1

#### **APPLICATION INFORMATION**



NOTE A: The value of this delay element is dependent on the speed of the microprocessor.

Figure 2. Typical Memory Interleave Application





#### PACKAGE OPTION ADDENDUM

24-Jun-2005

#### **PACKAGING INFORMATION**

www ti com

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp (3)
SN74BCT2423AFN	OBSOLETE	PLCC	FN	68	TBD	Call TI	Call TI
SN74BCT2424AFN	OBSOLETE	PLCC	FN	68	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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